

# **BDS-SM**

## **BDS-SM Family Picosecond Diode Lasers**

Small-size Module, 40 x 40 x 120 mm<sup>3</sup> or 40 x 70 x 120 mm<sup>3</sup>

Wavelengths 375, 405, 445, 473, 488, 515, 640, 685, 785, 1064 nm

Free-beam or single-mode fibre output

Pulse width down to < 40 ps

Pulse repetition rate 20 MHz, 50, 80 MHz, and CW mode

Sync input for synchronisation with external frequency

Power in pulsed mode up to 1.3/3/5 mW @ 20/50/80 MHz

Power in CW mode up to 50 mW

Fast ON/OFF and multiplexing capability

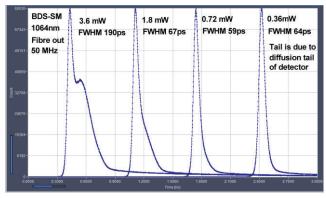
**Internal power stabilisation loop** 

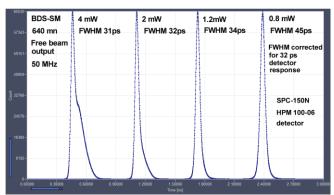
All electronics integrated, no external driver unit required

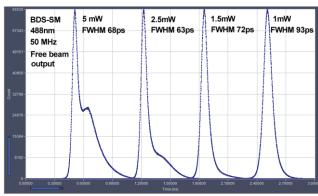
Simple +12 V power supply

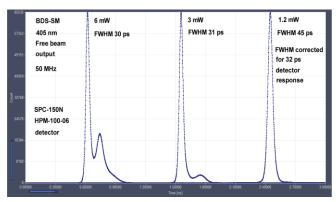
Compatible with all bh TCSPC devices











Pulse shapes and power levels may change due to development in laser diode technology. Coupling efficiency into single-mode fibres is 40 to 60 %.

### Designed and manufactured by



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Trigger Output for TCSPC Synchronisation

Repetition Rate, switchabel by TTL signal

Wavelengths

Pulse width (FWHM, at medium power)

Pulse width (FWHM, at maximum power)

Power control range (power in free beam)

Power control range (CW mode, power in free beam)

Beam diameter, free beam

Polarisation

Coupling efficiency into single-mode fibre, typically

#### **Trigger Output, to TCSPC Modules**

Pulse Amplitude Pulse Width

Output Impedance

Connector

Jitter between Trigger and Optical Pulse

#### **Synchronisation Input**

Input amplitude

Duty cycle

Input frequency

Connector

Switch between internal clock and sync input

### **Control Inputs**

Laser ON/OFF

Response of optical output to ON/OFF signal

External Power Control

Response time of optical output to power control

F1: 50 MHz

F2: 20 MHz

F3: 80 MHz

CW

#### **Power Supply**

Power Supply Voltage Power Supply Current at 12V

#### **Mechanical Data**

Dimensions (OEM)

Dimensions (w/ cooling)

Mounting holes

Heat sink requirements

#### **Connector Pin Assignment**

Connector version Power supply +12V

**GND** 

Power control voltage

Laser ON/OFF (TTL/CMOS, active H)

F2: 20 MHz (active H, int. pull-down resistor) F1: 50 MHz (active H, int. pull-up resistor) F3: 80 MHz (active H, int. pull-down resistor)

CW(active H, int. pull-down resistor) Do not connect:

#### **Maximum Values**

Power Supply Voltage

Voltage at 'Laser ON/OFF' and 'Frequency' inputs

Voltage at 'Laser Power' input

Ambient Temperature

 $20\ \text{MHz},\,50\ \text{MHz},\,80\ \text{MHz}$  and CW, other repetition rates on request 375, 405, 445, 470, 485, 515, 640, 685, 785, 1064 nm, other on request

30 to 90 ps 60 to 300 ps

0 to 1 mW ..... 0 to 5 mW (depends on wavelength version) 0 to 20 mW ..... 0 to 50 mW (depends on wavelength version) 0.8 mm (circular) or  $1 \times 3 \text{ mm}$  (elliptical, depends on version)

horizontal up to 60 % (circular version)

-1.2 V (peak) into 50  $\Omega$ 1 ns, see figure right  $50 \Omega$ SMA < 10 ps

+3.3 to +5 V into 50 Ω

10 to 30 %. DC equivalent must be < 2.5 V single pulse to 80 MHz / power control 10 to 80 MHz

SMA

automatic, by average voltage at trigger connector

TTL / CMOS, 'low' means 'OFF', internal pull-up < 4 us for power 10 to 100 %, see figures right analog input, 0 to  $\pm 10~V$ 

< 4 us for power 10 to 100 %, see figure right active H, internal pull-up resistor active H, internal pull-down resistor

active H, internal pull-down resistor active H, internal pull-down resistor

Laser runs at 50 MHz when Frequency/CW inputs unconnected

+ 9 V to +15 V  $200\ mA$  to  $500\ mA^{\ 1)}$ 

 $40 \text{ mm} \times 40 \text{ mm} \times 120 \text{ mm}$  $40 \text{ mm} \times 70 \text{ mm} \times 120 \text{ mm}$ four holes for M3 screws < 2 °C / W 2)

Mini Sub-D 15 pin 1.2

4, 5, and case 6

10 11, 12, 13, 14, 15

0 V to +15 V

-2 V to +7 V -12 V to +12 V 0 °C to +40 °C 2)

1) Depends on case temperature due to laser diode cooling. Cooling current changes with case temperature.
2) OEM version without active cooling must be mounted on heat sink. Case temperature must remain below 40 °C.

#### Related Products

BDS-MM picosecond diode lasers, BDL-SMN picosecond and CW diode lasers, 375, 405, 445, 473, 488, 515, 640, 685, 785, 1064 nm





Caution: Class 3B laser product. Avoid direct eye exposure. Light emitted by the device may be harmful to the human eye. Please obey laser safety rules when operating the devices. Complies with US federal laser product performance standards.

## International Sales Representatives



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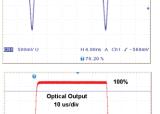


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Power Control Voltage 10V

Laser On/Off TTL / CMOS

GhI + 1.00 V Ω%Ch2 100mV %H 10.0µs A Ch1 √-140m

